

Amendments to the Specification

Please change the title to "Method For Fabricating Semiconductor Components By Forming Conductive Members Using Solder".

On page 2, line 1, please add the following "Cross Reference To Related Applications".

-- Cross Reference To Related Applications

This application is a continuation of serial no. 09/961,646, filed 09/25/2001, which is a division of serial no. 09/385,606, filed 08/30/1999, Patent No. 6,294,387, which is a division of serial no. 08/993,965, filed 12/18/1997, Patent No. 6,107,109.--